	BLE STAN				Storage				
	Temperature F	Range 2	-55 °C to 105 °	2 (1)	Temperatur	e Range	-10 °C to 6	0 °C	(2)
Rating	Voltage Current		Power Contact : 200 V AC		Storage Hur	orage Humidity Range Relative humidi		% max	
			Signal Contact : 0.5 A Power Contact : 3.0A			perating Humidity Range (Not dewed)			
			SPEC	IFICATIO	NS				
IT	EM		TEST METHOD			REQU	IREMENTS	QT	Α
CONSTRU	JCTION							1	
General Examination		Visually and by measuring instrument.			Accord	According to drawing.			>
Marking		Confirmed	visually.					×	;
ELECTRIC CHARAC		TERISTICS							
Contact Resistance		100 mA(DC or 1000Hz)			-	Signal Contact : 70m Ω MAX. Power Contact : 20m Ω MAX.			-
Insulation Resistance		Signal Contact : 100 V DC. Power Contact : 250 V DC			-	Signal Contact : $100 \text{ M}\Omega \text{ MIN}$. Power Contact : $1000 \text{ M}\Omega \text{ MIN}$.			-
Voltage Proof		Signal Contact : 150 V AC for 1 min.							;
		Power Contact : 600 V AC for 1 min.			No flas	No flashover or breakdown.			- 1
MECHANI	CAL CHAF	RACTERIS	TICS						
Insertion and		Measured by applicable connector.			Insertio	Insertion Force: 36 N MAX.			-
Withdrawal Forces						Withdrawal Force: 4 N MIN.			
Mechanical Operation		100 times insertions and extractions.			S	 Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No damage, crack and looseness of parts. 			_
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles			① No	 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
Shock		for 3 axial directions. 490 m/s ² , duration of pulse 11 ms						×	-
			for 3 both axial directions.						
	MENTAL C								-
Damp Heat (Steady state)		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			S	① Contact Resistance: Signal Contact : 80m Ω MAX.			-
Rapid Change of Temperature		Temperature $-55 \rightarrow +85 \text{ °C}$ Time $30 \rightarrow 30$ min. under 5 cycles.			-	Power Contact : 30m Ω MAX. ② Insulation Resistance: Signal Contact : 100 MΩ MIN.			-
					-				
			ime to chamber : within 2~3 M	IN)	F	ower Contact	: 1000 MΩ MIN.		
Cold		Exposed at -55°C, 96 h			1 Cor	③ No damage, crack and looseness of parts. ① Contact Resistance: × Signal Contact : 80m Ω MAX.			-
Dry Heat		Exposed at 105°C, 96 h			Р	Power Contact : 30m Ω MAX. × ② No damage, crack and looseness of parts. ×			
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h.				 No defect such as corrosion which impairs 			+-
		(Test standard: IEC 68)			the ② Cor S	 the function of connector. (2) Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. 			
Resistance to Soldering Heat		1)Reflow soldering : Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec				No deformation of case of excessive looseness of the terminal.			-
				sec.					
Solderability		2) Soldering irons : 360°C MAX. for 5 sec. Soldered at solder temperature			A new	uniform coatir	ng of solder shall cover a	×	+-
,			or immersion duration, 3 se	ec.		ım of 95 % of	the surface being		
COUN	T D	ESCRIPTIO	N OF REVISIONS	DES	SIGNED		CHECKED	DA	TE
2 2		DIS-F-	-00002065	TS. 00N0			HT. YAMAGUCHI	17.02.0	
REMARKS ⁽¹⁾ Include temperature rise caused by current-carrying. ⁽²⁾ "STORAGE" means a long-term storage state for the unused product before assembly to PCB. APPROVED HS. 0KAWA CHECKED KN. SHIBUYA								14.0 14.0	
		,				DESIGNED	TS. 00N0	14.08.1	
Unless otherwise specified, refer to IEC 60512.						DRAWN TS. 00N0)8. 1
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO. ELC-353561-0			0-00)
HRS		SPECIFICATION SHEET					X23-80S-0. 5SV10		
		バハビヒ ヒトロ	IROSE ELECTRIC CO., LTD.			DE NO. CL573-3304-2-00			1/